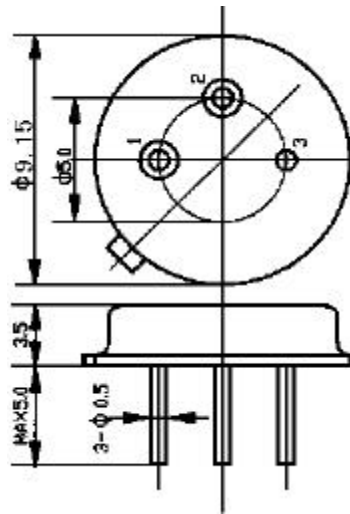


**1. Package Dimension**  
(TO-39)

Unit:mm

NO.	Function
1	Output /Input
2	Input/Output
3	GND



**2. Marking**

Regular ( Display the frequency)

2-1.Colour: Black or Blue

2-2.Center Frequency(MHz):433.92

**3.Performance**

3-1.Maximum Rating

DC Voltage $V_{DC}$	10V
AC Voltage $V_{PP}$	10V(50Hz/60Hz)
Operation Temperature	-40C to +85C
Storage Temperature	-40C to +85C
RF Power Dissipation	0 dBm

3-2Electronic Characteristics

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**Electrical Characteristics**

Characteristic		Sym	Minim	Typical	Maximu	Units
Center Frequency(+25°C)	Absolute Frequency	f <sub>c</sub>	433.845		433.995	MHz
	Tolerance from 433.92 MHz	Δf <sub>c</sub>		±5		kHz
Insertion Loss					1.0	dB
Quality Factor	Unloaded Q	Q <sub>U</sub>		12,800		
	50 Ω Loaded Q	Q <sub>L</sub>		2,000		
Temperature Stability	Turnover Temperature	T <sub>0</sub>	24	39	54	°C
	Turnover Frequency	f <sub>0</sub>		f <sub>c</sub> +2.7		kHz
	Frequency Temperature Coefficient	FTC		0.037		ppm/°C
Frequency Aging	Absolute Value during the First Year			±10		ppm/yr
DC Insulation Resistance between Any Two Pins			1.0			MΩ
RF Equivalent RLC Model	Motional Resistance	R <sub>M</sub>		13	26	Ω
	Motional Inductance	L <sub>M</sub>		82.3481		μH
	Motional Capacitance	C <sub>M</sub>		1.64228		fF
	Pin 1 to Pin 2 Static	C <sub>0</sub>		2.4		pF

☺ CAUTION: Electrostatic Sensitive Device. Observe precautions for handling

**NOTES:**

1. Frequency aging is the change in f<sub>c</sub> with time and is specified at +65°C or less. Aging may exceed the specification for prolonged temperatures above +65°C. Typically, aging is greatest the first year after manufacture, decreasing in subsequent years.
2. The frequency f<sub>c</sub> is the frequency of minimum IL with the resonator in the specified test fixture in a 50 Ω test system with VSWR ≤ 1.2 : 1. Typically, f<sub>oscillator</sub> or f<sub>transmitter</sub> is less than the resonator f<sub>c</sub>.
3. Typically, equipment utilizing this device requires emissions testing and government approval, which is the responsibility of the equipment manufacturer.
4. Unless noted otherwise, case temperature T<sub>c</sub> = +25°C ± 1°C.
5. The design, manufacturing process, and specifications of this device are subject to change without notice.
6. Derived mathematically from one or more of the following directly measured parameters: f<sub>c</sub>, IL, 3 dB bandwidth, f<sub>c</sub> versus T<sub>c</sub>, and C<sub>0</sub>.
7. Turnover temperature, T<sub>0</sub>, is the temperature of maximum (or turnover) frequency, f<sub>0</sub>. The nominal center frequency at any case temperature, T<sub>c</sub>, may be calculated from: f = f<sub>0</sub> [1 - FTC (T<sub>0</sub> - T<sub>c</sub>)<sup>2</sup>]. Typically, oscillator T<sub>0</sub> is 20°C less than the specified resonator T<sub>0</sub>.
8. This equivalent RLC model approximates resonator performance near the resonant frequency and is provided for reference only. The capacitance C<sub>0</sub> is the measured static (nonmotional) capacitance between either pin 1 and ground or pin 2 and ground. The measurement includes case parasitic capacitance.

Note: Reference temperature shall be 25 ± 2°C. However, the measurement may be carried out at 5°C to 35°C unless there is a dispute.

**4. Reliability**

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- 4.1 Mechanical Shock: The components shall remain within the electrical specifications after 1000 shocks, acceleration  $392\text{m/s}^2$ , duration 6 milliseconds.
- 4.2 Vibration Fatigue: The components shall remain within the electrical specifications after loaded vibration at 20 Hz , amplitude 1.5mm , for 2 hours.
- 4.3 Terminal Strength: The components shall remain within the electrical specifications after pulled 2 Kgs weight for 10 seconds towards an axis of each terminal.
- 4.4 High Temperature Storage: The components shall remain within the electrical specifications after being kept at the  $85 \pm 2$  for 48 hours, then kept at room temperature for 2 hours.
- 4.5 Low Temperature Storage: The components shall remain within the electrical specifications after being kept at the  $-25 \pm 2$  for 48 hours ,then kept room temperature for 2 hours.
- 4.6 Temperature Cycle: The components shall remain within the electrical specifications after 5 cycles of high and low temperature testing(one cycle:  $80 \pm 3$  for 30 minutes  $\rightarrow 25 \pm 5$  for 5 minutes  $\rightarrow -25 \pm 5$  for 30 minutes ) than kept at room temperature for 2 hours.
- 4.7 Solder-heat Resistance : The components shall remain within the electrical specifications after dipped in the solder at  $260 \pm 1$  seconds,then kept at room temperature for 2 hours .(Terminal must be dipped leaving 1.5 mm from the case).
- 4.8 Solder ability: Solder ability of terminal shall be kept at more than 80% after dipped in the solder flux at  $230 \pm 5$  for  $5 \pm 1$  seconds.

## 5. Remarks

### 5.1 Static voltage

Static voltage between signal load & ground may cause deterioration & destruction of the component. Please avoid static voltage .

### 5.2 Ultrasonic cleaning

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning.

### 5.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.